

SMT power inductors

Size $7.3 \times 7.3 \times 4.5$ (mm)

Series/Type: B82472G6

Date: June 2012

© EPCOS AG 2015. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.



B82472G6

SMT power inductors

Size 7.3 x 7.3 x 4.5 (mm)

SMD

Rated inductance 1 ... 1000 µH Rated current 0.2 ... 3.6 A

Construction

- Ferrite core
- Magnetically shielded
- Winding: enamel copper wire
- Winding soldered to terminals

Features

- Temperature range up to +125 °C
- High rated current
- Low DC resistance
- Suitable for lead-free reflow soldering
- RoHS-compatible

Applications

- Filtering of supply voltages
- Coupling/decoupling
- DC/DC converters
- Industrial electronics
- Consumer electronics

Terminals

- Base material CuSn6P
- Layer composition Ni, Sn (lead-free)
- Electro-plated

Marking

- Marking on component:
 L value (μH, coded), manufacturing date (YWWD)
- Minimum data on reel: Manufacturer, ordering code, L value, quantity, date of packing

Delivery mode and packing unit

- 16-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 1000 pcs./reel



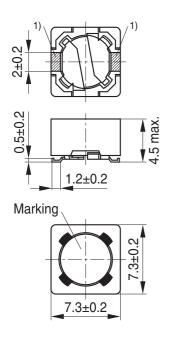
SMT power inductors

B82472G6

Size 7.3 x 7.3 x 4.5 (mm)

SMD

Dimensional drawing and layout recommendation



1.5 4.9 1.5 IND0487-U

1) Soldering area

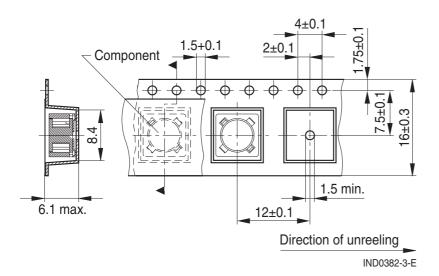
IND0488-G-E

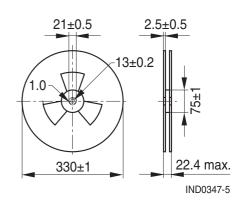
Dimensions in mm

Reel

Taping and packing

Blister tape





Dimensions in mm



SMT power inductors	B82472G6
---------------------	----------

Size 7.3 x 7.3 x 4.5 (mm)

SMD

Technical data and measuring conditions

Rated inductance L _R	Measured with LCR meterAgilent 4284A at frequency f _L , 0.1 V, +20 °C
Rated temperature T _R	+85 °C
Rated current I _R	Max. permissible DC with temperature increase of ≤ 40 K at rated temperature
Saturation current I _{sat}	Max. permissible DC with inductance decrease $\Delta L/L_0$ of approx. 10%
DC resistance R _{max}	Measured at +20 °C
Solderability (lead-free)	Dip and look method Sn95.5Ag3.8Cu0.7: $+(245 \pm 5)$ °C, (5 ± 0.3) s Wetting of soldering area $\geq 90\%$ (based on IEC 60068-2-58)
Resistance to soldering heat	+260°C, 10 s based on IEC 60068-2-58
Climatic category	55/125/56 (to IEC 60068-1)
Storage conditions	Mounted: -55 °C +125 °C Packaged: -25 °C +40 °C, ≤75% RH
Weight	Approx. 1.5 g



SMT power inductors B82472G6

Size 7.3 x 7.3 x 4.5 (mm)

SMD

Characteristics and ordering codes

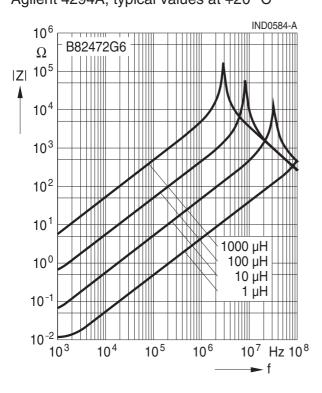
L _R	Tolerance	fL	I _R	I _{sat}	R _{max}	Ordering code
μΗ		MHz	Α	Α	Ω	
1.0	±20% ≙ M	0.1	3.60	3.30	0.015	B82472G6102M000
1.5		0.1	3.40	3.00	0.017	B82472G6152M000
2.2		0.1	3.00	2.80	0.020	B82472G6222M000
3.3		0.1	2.85	2.50	0.023	B82472G6332M000
4.7		0.1	2.50	2.00	0.030	B82472G6472M000
6.8		0.1	2.15	1.70	0.040	B82472G6682M000
10		0.1	1.90	1.40	0.053	B82472G6103M000
15		0.1	1.53	1.35	0.080	B82472G6153M000
22		0.1	1.45	1.30	0.091	B82472G6223M000
33		0.1	1.15	1.05	0.15	B82472G6333M000
47		0.1	1.00	0.90	0.20	B82472G6473M000
68		0.1	0.82	0.68	0.26	B82472G6683M000
100		0.1	0.67	0.55	0.39	B82472G6104M000
150		0.1	0.53	0.43	0.58	B82472G6154M000
220		0.1	0.43	0.36	0.88	B82472G6224M000
330		0.1	0.33	0.30	1.70	B82472G6334M000
470		0.1	0.29	0.25	2.00	B82472G6474M000
680		0.1	0.25	0.20	2.75	B82472G6684M000
820		0.1	0.24	0.23	3.30	B82472G6824M000
1000		0.1	0.20	0.15	3.85	B82472G6105M000

Sample kit available. Ordering code: B8247XX001 For more information refer to chapter "Sample kits".



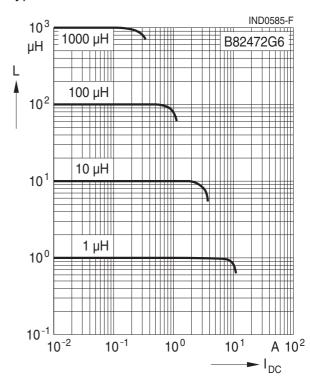
Size 7.3 x 7.3 x 4.5 (mm)

Impedance |Z| versus frequency f measured with impedance analyzer Agilent 4294A, typical values at +20 °C

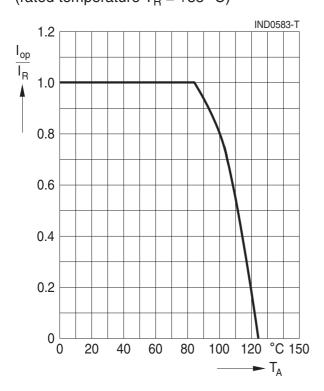


<u>SMD</u>

Inductance L versus DC load current I_{DC} measured with LCR meter Agilent 4275A, typical values at +20 °C



Current derating I_{op}/I_R versus ambient temperature T_A (rated temperature $T_B = +85$ °C)





Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
 Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.epcos.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order.
 - We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
- 6. Unless otherwise agreed in individual contracts, all orders are subject to the current version of the "General Terms of Delivery for Products and Services in the Electrical Industry" published by the German Electrical and Electronics Industry Association (ZVEI).
- 7. The trade names EPCOS, BAOKE, Alu-X, CeraDiode, CeraLink, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, FilterCap, FormFit, MiniBlue, MiniCell, MKD, MKK, MLSC, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, ThermoFuse, WindCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.epcos.com/trademarks.

8

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

EPCOS:

<u>B82472G6102M</u> <u>B82472G6103M</u> <u>B82472G6104M</u> <u>B82472G6105M</u> <u>B82472P6472M000</u> <u>B82472P6153M000</u>						
B82472G6152M000	B82472G6153M000	B82472G6154M000	B82472G6222M000	B82472G6223M000		
B82472G6224M000	B82472G6332M000	B82472G6333M000	B82472G6334M000	B82472G6472M000		
B82472G6473M000	B82472G6474M000	B82472G6682M000	B82472G6683M000	B82472G6684M000		
B82472P6102M000	B82472P6103M000	B82472P6104M000	B82472P6105M000	B82472P6152M000		
B82472P6154M000	B82472P6222M000	B82472P6223M000	B82472P6224M000	B82472P6332M000		
B82472P6333M000	B82472P6334M000	B82472P6473M000	B82472P6474M000	B82472P6682M000		
B82472P6683M000	B82472P6684M000	B82472G6824M				